What is claimed is:

- A barrier stack comprising:
 - a first barrier layer; and
- a second barrier layer, wherein the grain boundaries
 of the first and second barrier layer are mismatched to
 enhances the barrier properties of the barrier stack.
 - 2. The barrier stack of claim 1 further comprises:
 - a capacitor having a dielectric layer disposed
- 10 between first and second electrodes; and
 - a plug electrically coupled to the first electrode, wherein the barrier stack is disposed between the plug and first electrode.
- 15 3. The barrier stack of claim 2 further comprises an adhesion layer between the barrier stack and the plug.
 - 4. The barrier stack of claim 1 further comprises:
 - a ferroelectric capacitor having a ferroelectric
- 20 layer disposed between first and second electrodes; and
 - a plug electrically coupled to the first electrode, wherein the barrier stack is disposed between the plug and first electrode.

- 5. The barrier stack of claim 4 further comprises an adhesion layer between the barrier stack and plug.
- 6. The barrier stack of claim 1, 2, 3, 4, or 5 further comprises elements stuffing the grain boundaries of the first barrier layer, wherein the elements comprise a diameter greater than the grain boundaries of the first barrier layer.
- 7. The barrier stack of claim 6 further comprises elements stuffing the grain boundaries of the second barrier layer, wherein the elements comprise a diameter greater than the grain boundaries of the second barrier layer.

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- 8. The barrier stack of claim 7 further comprises a first oxide layer disposed on the surface of the first barrier layer.
- 20 9. The barrier stack of claim 7 further comprises a second oxide layer disposed on the surface of the second barrier layer.
- 10. The barrier stack of claim 7 wherein the elements25 comprise oxygen.

11. The barrier stack of claim 10 further comprises a first oxide layer disposed on the surface of the first barrier layer.

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- 12. The barrier stack of claim 10 further comprises a second oxide layer disposed on the surface of the second barrier layer.
- 10 13. The barrier stack of claim 6 wherein the elements comprise oxygen.
- 14. The barrier stack of claim 13 further comprises a first oxide layer disposed on the surface of the first barrier layer.
 - 15. The barrier stack of claim 6 wherein the barrier layers comprise a material selected from the group of materials comprising Ir, Rh, Ru, Pd, or alloys thereof.

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- 16. The barrier stack of claim 15 wherein the first and second barrier layers comprise different materials
- 17. The barrier stack of claim 15 wherein the first and second barrier layers comprise the same material.

- 18. The barrier stack of claim 15 wherein the first and second barrier layers comprise Ir.
- 5 19. The barrier stack of claim 10 wherein the barrier layers comprise a material selected from the group of materials comprising Ir, Rh, Ru, Pd, or alloys thereof.
- 20. The barrier stack of claim 19 wherein the first and second barrier layers comprise different materials
 - 21. The barrier stack of claim 19 wherein the first and second barrier layers comprise the same material.
- 15 22. The barrier stack of claim 19 wherein the first and second barrier layers comprise Ir.
- 23. The barrier stack of claim 13 wherein the barrier layers comprise a material selected from the group of20 materials comprising Ir, Rh, Ru, Pd, or alloys thereof.
 - 24. The barrier stack of claim 23 wherein the first and second barrier layers comprise different materials.

- 25. The barrier stack of claim 23 wherein the first and second barrier layers comprise the same material.
- 26. The barrier stack of claim 23 wherein the first and second barrier layers comprise Ir.